

MOSFET

650V CoolMOS™ C7 Power Device

CoolMOS™ is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies.

CoolMOS™ C7 series combines the experience of the leading SJ MOSFET supplier with high class innovation. The product portfolio provides all benefits of fast switching superjunction MOSFETs offering better efficiency, reduced gate charge, easy implementation and outstanding reliability.

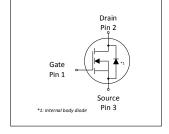
PG-TO 220 FP

Features

- Increased MOSFET dv/dt ruggedness
- Better efficiency due to best in class FOM R_{DS(on)}*E_{oss} and R_{DS(on)}*Q_g
- Best in class R_{DS(on)} /package
- · Easy to use/drive
- Pb-free plating, halogen free mold compound

Benefits

- Enabling higher system efficiency
- Enabling higher frequency / increased power density solutions
- System cost / size savings due to reduced cooling requirements
- Higher system reliability due to lower operating temperatures









Potential applications

PFC stages and hard switching PWM stages for e.g. Computing, Server, Telecom, UPS and Solar.

Product validation

Fully qualified according to JEDEC for Industrial Applications

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.

Table 1 Key Performance Parameters

Parameter	Value	Unit	
V _{DS} @ T _{j,max}	700	V	
R _{DS(on),max}	45	mΩ	
$Q_{g.typ}$	93	nC	
I _{D,pulse}	212	А	
E _{oss} @400V	11.7	μJ	
Body diode di/dt	60	A/µs	

Type / Ordering Code	Package	Marking	Related Links
IPA65R045C7	PG-TO 220 FullPAK	65C7045	see Appendix A





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1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Davamastan	Ols al		Value	S	11	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	-	-	18 11	А	T _C =25°C T _C =100°C
Pulsed drain current ²⁾	I _{D,pulse}	-	-	212	Α	T _C =25°C
Avalanche energy, single pulse	E AS	-	-	249	mJ	I_D =12A; V_{DD} =50V; see table 10
Avalanche energy, repetitive	E AR	-	-	1.25	mJ	I_D =12A; V_{DD} =50V; see table 10
Avalanche current, single pulse	I _{AS}	-	-	12.0	Α	-
MOSFET dv/dt ruggedness	dv/dt	-	-	100	V/ns	V _{DS} =0400V
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)
Power dissipation	P _{tot}	-	-	35	W	T _C =25°C
Storage temperature	T _{stg}	-55	-	150	°C	-
Operating junction temperature	T _j	-55	-	150	°C	-
Mounting torque	-	-	-	50	Ncm	M2.5 screws
Continuous diode forward current	Is	-	-	18	Α	T _C =25°C
Diode pulse current ²⁾	I _{S,pulse}	-	-	212	Α	T _C =25°C
Reverse diode dv/dt ³⁾	dv/dt	-	-	1.5	V/ns	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <= $I_{\rm S}$, $T_{\rm j}$ =25°C see table 8
Maximum diode commutation speed	di _f /dt	-	-	60	A/μs	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <= $I_{\rm S}$, $T_{\rm j}$ =25°C see table 8
Insulation withstand voltage	V _{ISO}	-	-	2500	V	$V_{\rm rms}$, $T_{\rm C}$ =25°C, t =1min

 $^{^{1)}}$ Limited by $T_{j\,max}.$ $^{2)}$ Pulse width t_p limited by $T_{j,max}$ $^{3)}$ Identical low side and high side switch with identical \textit{R}_{G}

IPA65R045C7



2 Thermal characteristics

Table 3 Thermal characteristics

Davamatav	Cumbal	Values			11	Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	3.6	°C/W	-
Thermal resistance, junction - ambient		-	-	80	°C/W	leaded
Thermal resistance, junction - ambient for SMD version	R _{thJA}	-	-	-	°C/W	n.a.
Soldering temperature, wavesoldering only allowed at leads	T _{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s

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3 Electrical characteristics

at T_j=25°C, unless otherwise specified

Table 4 Static characteristics

Davamatan	Correspond		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	650	-	-	V	V_{GS} =0V, I_D =1mA
Gate threshold voltage	$V_{(GS)th}$	3	3.5	4	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 1.25 \rm mA$
Zero gate voltage drain current	I _{DSS}	-	- 20	2 -	μΑ	V _{DS} =650, V _{GS} =0V, T _i =25°C V _{DS} =650, V _{GS} =0V, T _i =150°C
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.040 0.096	0.045	Ω	V _{GS} =10V, I _D =24.9A, T _j =25°C V _{GS} =10V, I _D =24.9A, T _j =150°C
Gate resistance	R _G	-	0.85	-	Ω	f=1MHz, open drain

Table 5 Dynamic characteristics

Damamadan	Or week all		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	4340	-	pF	V _{GS} =0V, V _{DS} =400V, <i>f</i> =250kHz
Output capacitance	Coss	-	70	-	pF	V _{GS} =0V, V _{DS} =400V, <i>f</i> =250kHz
Effective output capacitance, energy related ¹⁾	C _{o(er)}	-	146	-	pF	V _{GS} =0V, V _{DS} =0400V
Effective output capacitance, time related ²⁾	C _{o(tr)}	-	1630	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0400V
Turn-on delay time	t _{d(on)}	-	20	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =24.9A, $R_{\rm G}$ =3.3 Ω ; see table 9
Rise time	t _r	-	14	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =24.9A, $R_{\rm G}$ =3.3 Ω ; see table 9
Turn-off delay time	$t_{ m d(off)}$	-	82	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =24.9A, $R_{\rm G}$ =3.3 Ω ; see table 9
Fall time	t _f	-	7	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13 V, $I_{\rm D}$ =24.9A, $R_{\rm G}$ =3.3 Ω ; see table 9

Table 6 Gate charge characteristics

Parameter	Cumbal	Values			11:4	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	23	-	nC	V_{DD} =400V, I_{D} =24.9A, V_{GS} =0 to 10V
Gate to drain charge	Q_{gd}	-	30	-	nC	V_{DD} =400V, I_{D} =24.9A, V_{GS} =0 to 10V
Gate charge total	Qg	-	93	-	nC	V_{DD} =400V, I_{D} =24.9A, V_{GS} =0 to 10V
Gate plateau voltage	V _{plateau}	-	5.4	-	V	V_{DD} =400V, I_{D} =24.9A, V_{GS} =0 to 10V

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V

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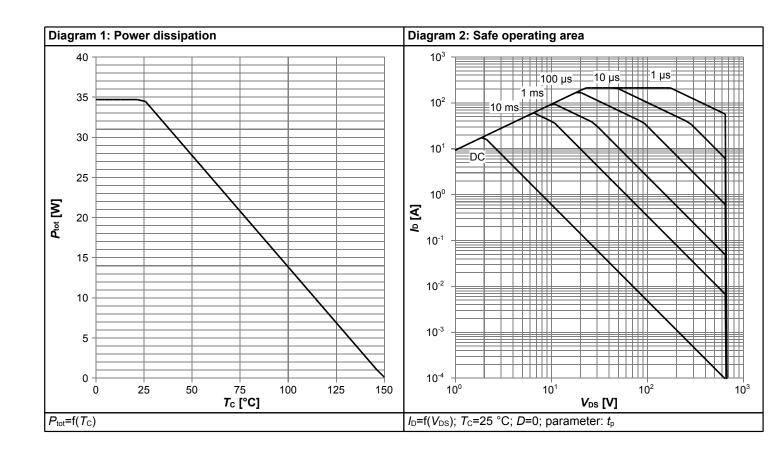


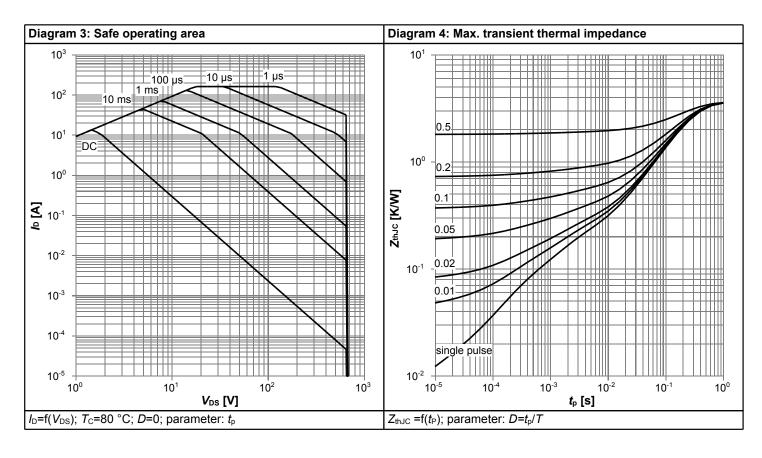
Table 7 Reverse diode characteristics

Doromotor	Symbol	Values			l lmit	Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode forward voltage	V _{SD}	-	0.9	-	V	V _{GS} =0V, I _F =24.9A, T _j =25°C
Reverse recovery time	t _{rr}	-	725	-	ns	V_R =400V, I_F =18A, di_F/dt =60A/ μ s; see table 8
Reverse recovery charge	Qrr	-	13	-	μC	V_R =400V, I_F =18A, di_F/dt =60A/ μ s; see table 8
Peak reverse recovery current	I _{rrm}	-	36	-	А	V_R =400V, I_F =18A, di_F/dt =60A/ μ s; see table 8

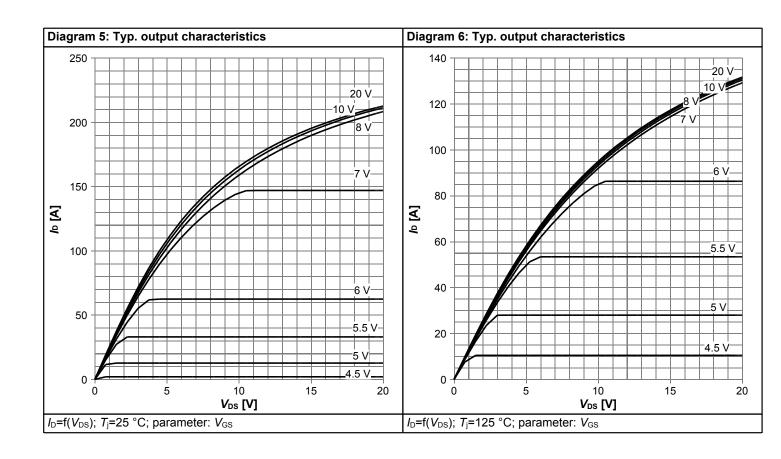


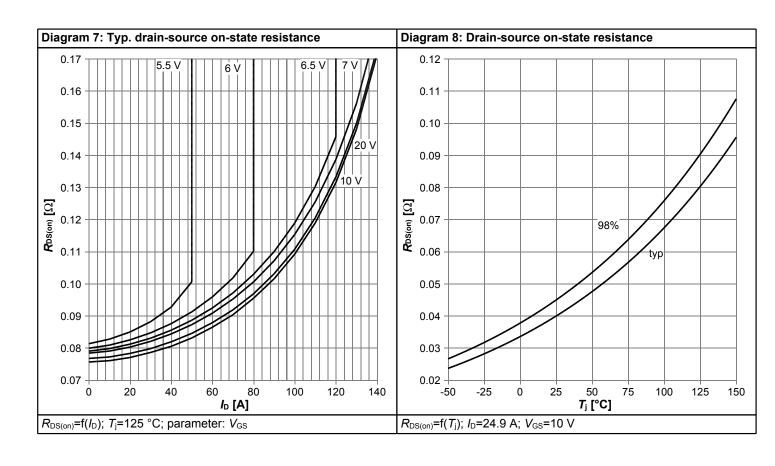
4 Electrical characteristics diagrams



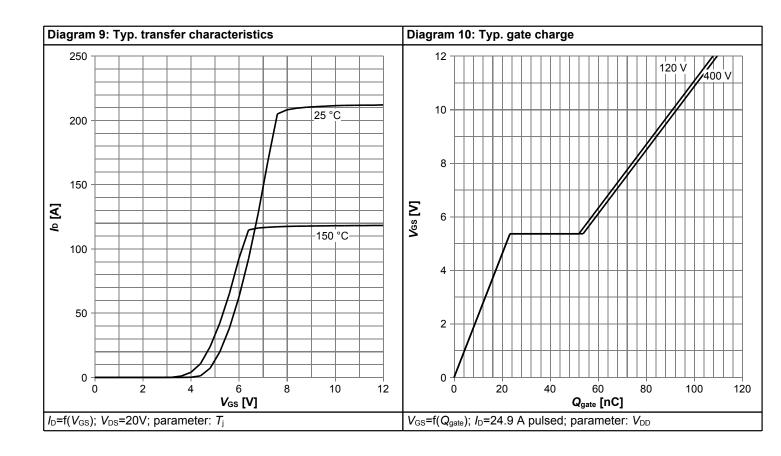


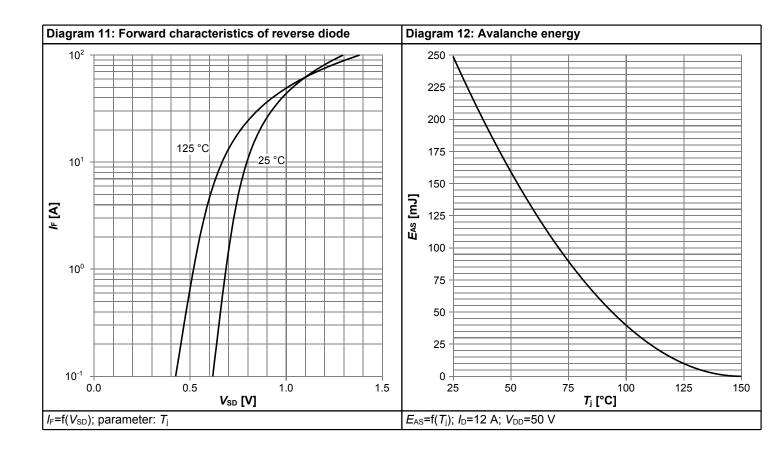




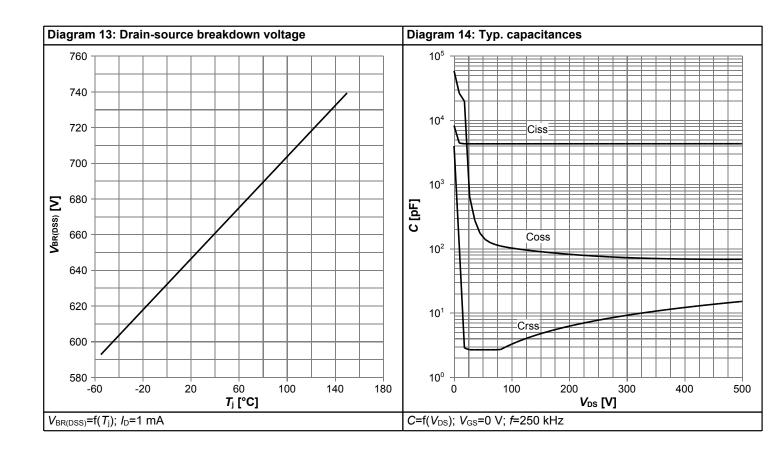


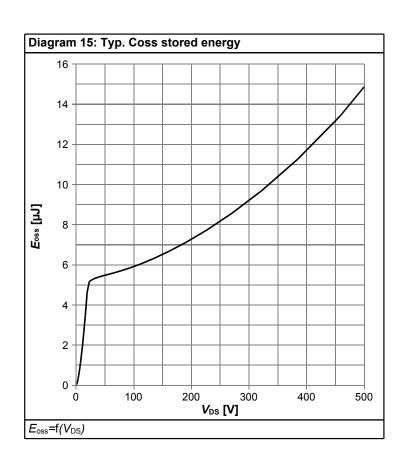














5 Test Circuits

Table 8 Diode characteristics

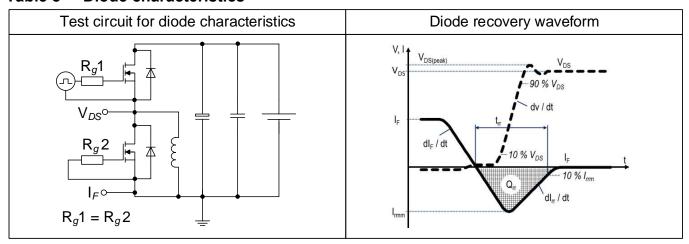


Table 9 Switching times

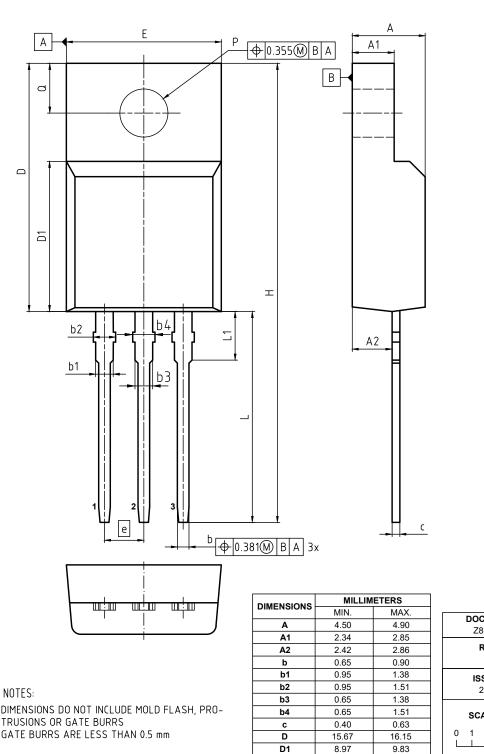


Table 10 Unclamped inductive load





Package Outlines 6



DIMENSIONS DO NOT INCLUDE MOLD FLASH, PRO-TRUSIONS OR GATE BURRS GATE BURRS ARE LESS THAN 0.5 mm

DIMENSIONS				
DIMENSIONS	MIN.	MAX.		
Α	4.50	4.90		
A1	2.34	2.85		
A2	2.42	2.86		
b	0.65	0.90		
b1	0.95	1.38		
b2	0.95	1.51		
b3	0.65	1.38		
b4	0.65	1.51		
С	0.40	0.63		
D	15.67	16.15		
D1	8.97	9.83		
E	10.00	10.65		
е	2.54			
Н	28.70	29.75		
L	12.78	13.75		
L1	2.83	3.45		
øΡ	3.00	3.30		
Q	3.15	3.50		

DOCUMENT NO.						
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SCALE 5:1 0 1 2 3 4 5mm						
EUROPEAN PROJECTION						

Figure 1 Outline PG-TO 220 FullPAK, dimensions in mm

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7 Appendix A

Table 11 Related Links

• IFX CoolMOS™ C7 Webpage: www.infineon.com

• IFX CoolMOS[™] C7 application note: <u>www.infineon.com</u>

• IFX CoolMOS™ C7 simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

IPA65R045C7



Revision History

IPA65R045C7

Revision: 2020-01-29, Rev. 2.1

Previous	Revision

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Revision	Date	Subjects (major changes since last revision)
2.0	2013-10-18	Release of final version
2.1	2020-01-29	Updated package drawing, symbol ID and product validation

Trademarks

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